



TECHNICAL INFORMATION

POLYETHYLENE COMPOUNDS

ETHYLPLUS 611LE

August 2024

THERMOPLASTIC LOW DENSITY POLYETHYLENE COMPOUND FOR CELLULAR INSULATION OF COMMUNICATION CABLES

Description

Ethylplus 611 LE is a polyethylene and halogen free compound containing a chemical blowing agent, which ensure a fine foam structure and low electrical losses. It can be used in coaxial applications and for the production of CATV cables.

Technical characteristics of the compound in the solid form before expansion:

Property	Test method	Unit	Typical Value
Density	ISO 1183	g/cm ³	0.93
Hardness at 15"	ISO 868	Shore D	44
Tensile strength (v = 250 mm/min)	ISO 527	N/mm ²	> 12.0
Elongation at break (v = 250 mm/min)	ISO 527	%	> 300
Melt Flow Index (140 ${ m C}/5$ Kg)	ISO 1133	g/10 min	8.0
Volume Resistivity 20 °C (Alternating Polarity Method)	ASTM D257 Electrodes	Ω·cm	> 1 · 10 ¹⁶

The typical values reported in the table have been obtained from measurements made on extruded samples or pressed plates

Processing

This thermoplastic compound has been formulated for an easy processing, and optimal output can be generally achieved on extruders with $L \ge 20D$ using a temperature profile set between $120^{\circ}C$ and $160^{\circ}C$.

Packaging

Available in 20 Kg PE bags, big bags or oktabins of 1000 Kg.

Our technical service is at your disposal, for further information and assistance.

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